

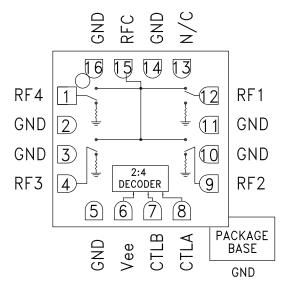


## Typical Applications

The HMC344LC3 is ideal for:

- Broadband, Military, Radar & ECM
- Fiber Optics
- Switched Filter Banks
- Wireless below 8 GHz
- Test Instrumentation

## **Functional Diagram**



#### **Features**

Broadband Performance: DC - 8 GHz

Integrated 2:4 TTL Decoder
High Isolation: 40 dB@ 6 GHz
Low Insertion Loss: 2 dB@ 6 GHz

Non-Reflective Topology

## **General Description**

The HMC344LC3 is a broadband non-reflective GaAs MESFET SP4T switch in a ceramic 3x3 mm leadless surface mount package. Covering DC to 8 GHz, this switch offers high isolation and low insertion loss. The HMC344LC3 includes an integrated binary decoder circuit which reduces the required logic control lines to two. The switch operates using a negative control voltage of 0/-5V, and requires a fixed bias of -5V. Simple external level shifting circuitry allows this switch to be controlled with most TTL/CMOS positive logic families.

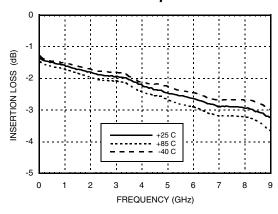
# Electrical Specifications, $T_A = +25^{\circ}$ C, With 0/-5V Control, 50 Ohm System

Parameter		Frequency	Min.	Тур.	Max.	Units
Insertion Loss		DC - 2.0 GHz DC - 6.0 GHz DC - 8.0 GHz		1.6 2.0 2.5	2.0 2.8 3.0	dB dB dB
Isolation		DC - 2.0 GHz DC - 4.0 GHz DC - 6.0 GHz DC - 8.0 GHz	43 35 32 30	50 45 45 40		dB dB dB dB
Return Loss	"On State"	DC - 2.0 GHz DC - 4.0 GHz DC - 6.0 GHz DC - 8.0 GHz	15 12 12 12	17 16 16 17		dB dB dB dB
Return Loss	"Off State"	DC - 8.0 GHz	12	15		dB
Input Power for 0.1 dB Compression		0.5 - 8.0 GHz	22	26		dBm
Input Third Order Intercept (Two-Tone Input Power = +7 dBm Each Tone)		0.5 - 8.0 GHz		43		dBm
Switching Characteristics tRISE, tFALL (10/90% RF) tON, tOFF (50% CTL to 10/90% RF)		DC - 8.0 GHz		20 70		ns ns

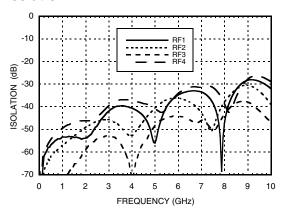




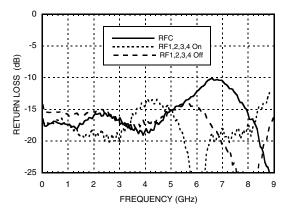
### Insertion Loss vs. Temperature



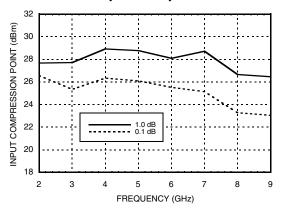
#### Isolation



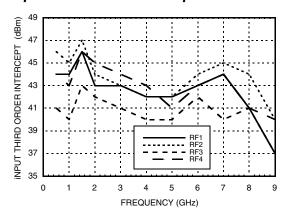
### **Return Loss**



### 0.1 and 1 dB Input Compression Point



### Input Third Order Intercept Point



## Bias Voltage & Current

Vee Range = -5.0 Vdc ± 10%			
Vee (Vdc)	lee (Typ.) (mA)	lee (Max.) (mA)	
-5.0	3.0	6.0	

## **Control Voltages**

	State	Bias Condition
	Low	-3V to 0 Vdc @ 60 μA Typical
High		-5 to -4.2 Vdc @ 5 μA Typical

<sup>\*</sup> Isolation is recorded above insertion loss & measured at output of switch.





# **Absolute Maximum Ratings**

Bias Voltage Range (Vee)	-7.0 Vdc
Control Voltage Range (A & B)	Vee -0.5V to +1.0 Vdc
Channel Temperature	150 °C
Thermal Resistance (Insertion Loss Path)	100 °C/W
Thermal Resistance (Terminated Path)	180 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C
Maximum Input Power (Low Loss State)	+28 dBm
ESD Sensitivity (HBM)	Class 1A

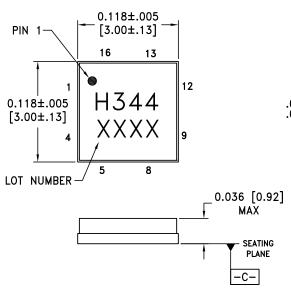
#### **Truth Table**

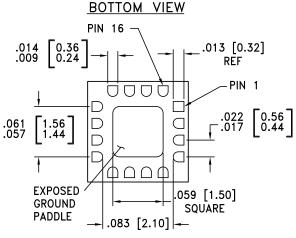
Control Input		Signal Path State	
А	В	RFC to:	
High	High	RF1	
Low	High	RF2	
High	Low	RF3	
Low	Low	RF4	



ELECTROSTATIC SENSITIVE DEVICE OBSERVE HANDLING PRECAUTIONS

# **Outline Drawing**





#### NOTES:

- 1. PACKAGE BODY MATERIAL: ALUMINA
- 2. LEAD AND GROUND PADDLE PLATING: 30-80 MICROINCHES GOLD OVER 50 MICROINCHES MINIMUM NICKEL.
- 3. DIMENSIONS ARE IN INCHES [MILLIMETERS].
- 4. LEAD SPACING TOLERANCE IS NON-CUMULATIVE.
- 5. PACKAGE WARP SHALL NOT EXCEED 0.05mm DATUM -C-
- 6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.





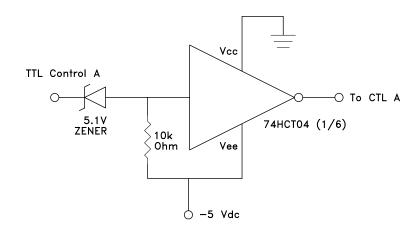
# **Pin Descriptions**

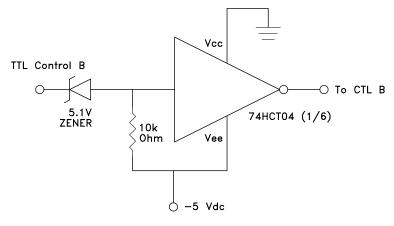
Pin Number	Function	Description	Interface Schematic	
1, 4, 9, 12, 15	RF4, RF3, RF2, RF1, RFC	This pin is DC coupled and matched to 50 Ohm. Blocking capacitors are required if RF line potential is not equal to 0V.		
2, 3, 5, 10, 11, 14, 16	GND	Package bottom has exposed metal paddle that must also be connected to PCB RF ground.	→ GND =	
6	Vee	Supply Voltage -5V ± 10%	Vee ○	
7	CTLB	See truth table and control voltage table.	0.5K 100K	
8	CTLA	See truth table and control voltage table.	CTLA = -	
13	N/C	This pin should be connected to PCB RF ground to maximize isolation.		





## **TTL Interface Circuit**

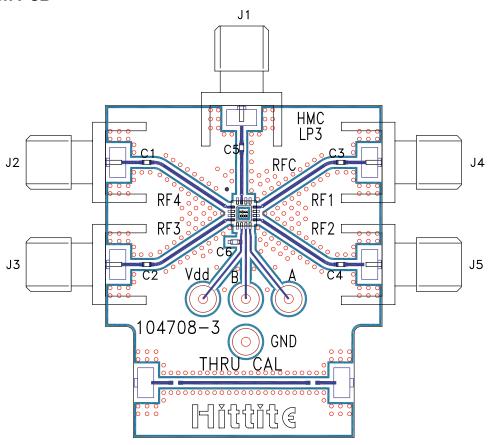








#### **Evaluation PCB**



#### List of Materials for Evaluation PCB 105311 [1]

Item	Description
J1 - J7	PCB Mount SMA RF Connector
J8 - J11	DC Pin
C1 - C5	0Ω Resistor, 0402 Pkg. <sup>[3]</sup>
C6	1000 pF Capacitor, 0402 Pkg.
U1	HMC344LC3
PCB [2]	104708 Evaluation PCB 1.29"x1.55"

[1] Reference this number when ordering complete evaluation PCB  $\,$ 

[3] Select and replace with a suitable capacitor value for applicable operating frequency range.

The circuit board used in the application should be generated with proper RF circuit design techniques. Signal lines at the RF port should have 50 ohm impedance and the package ground leads and backside ground slug should be connected directly to the ground plane similar to that shown above. The evaluation circuit board shown above is available from Hittite Microwave Corporation upon request.

<sup>[2]</sup> Circuit Board Material: Rogers 4350